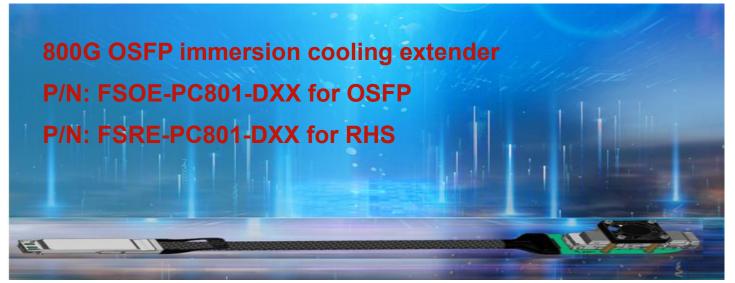
FIBERSTAMP





Features

- ♦ Compliant OSFP MSA
- ♦ Typical insertion loss less 8dB@26.56GHz with 0.3m length
- ♦ 100ohm differential impedance system
- 3.3V power supply
- ♦ I2C R/W function
- ♦ Status indicators with LED
- ♦ 3.3V/0.85W fan and heat sink for contact cooling
- ♦ Low EMI radiation and crosstalk
- ♦ RoHS compliant(lead free)

Applications

- ♦ Extend 800G OSFP transceiver/AOC for liquid immersion link environment
- ♦ Protect device OSFP SMT connector
- ♦ provide I2C R/W and some status indicators with LED

Description

FIBERSTAMP can offer rich experience of immersion solution, that includes different form and speed transceivers/AOC/product. FIBERSTAMP 800G OSFP immersion cooling extender (FSOE-PC801-DXX) is an important part of liquid immersion solution, normal OSFP form transceiver/AOC can be used for immersion environment with this product. This product include extender cage, cable, OSFP housing three parts, the cable length can be customized no more than 0.3m for extension, that can avoid the optical lens/engine/interface exposure to the liquid indirectly.

In addition, this product can provide I2C read/write, also can show the status indicators with LED for low speed electrical hardware pins. When insertion and removal frequently, this product can effectively protect the OSFP SMT connector of switch/NIC.

Liquid cooling Advantage

Air cooling compare liquid cooling Air cooling Air cooling server & High low Temperature eat dissipation temperature air Liquid cooling Liquid cooling server High temperature Normal temperature system: liquid cooling eat dissipation liquid

Figure 1. Liquid cooling advantage





As the requirement of data traffic keeping growth and the heat flux emitted by datacenter internal chips increases constantly, traditional air cooling methods are under pressure. Liquid cooling technologies removes the heat more efficiently with dielectric fluids that have high heat capacity to improve the efficiency of energy in datacenter.

FIBERSTAMP solved the lack of optical transceivers which perform reliability in immersion even liquid immersion depth up to 10m, the Liquid cooling optical series transceiver is suitable for liquid cooling server & system, this series product are compatible with fluorinated liquid and mineral oils well.

Immersion cooling extender can also be a important role in liquid immersion solution, existing normal OSFP form transceiver/AOC can be adapted for immersion indirectly.



Figure 2 Immersion cooling extender under liquid

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Storage Temperature	Ts	-20	85	°C
Case Operating Temperature	Tc	0	70	°C
Humidity (non-condensing)	Rh	5	95	%

Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Supply Voltage	Vcc	3.13		3.47	V
Support Power Dissipation	Pm			16	w
Operating Case Temperature	T _c	0		70	°C
Baud Rate per Lane	fd		53.125		GBaud/s

Main Part assembly

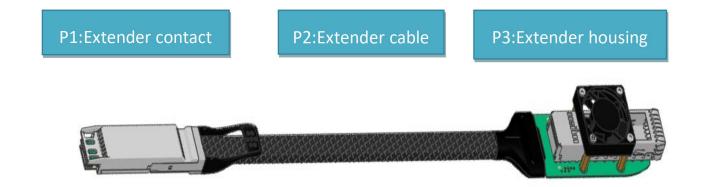
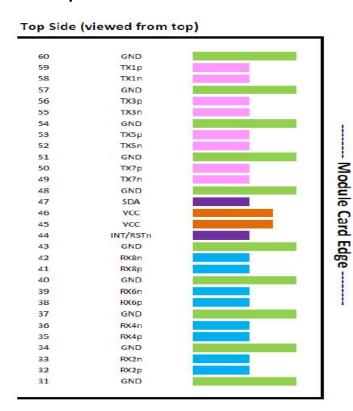


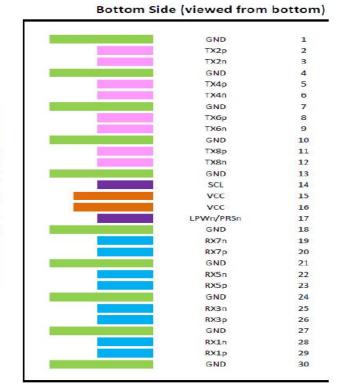
Figure 3 OSFP extender main part assembly





Electrical pinout





Electrical Pin-out Details

Pin# Symbol		Description	Logic	Direction	Plug Sequence	Notes	
1	GND	Ground			1		
2	TX2p	Transmitter Data Non-Inverted	CML-I	Input from Host	3		
3	TX2n	Transmitter Data Inverted	CML-I	Input from Host	3		
4	GND	Ground			1		
5	TX4p	Transmitter Data Non-Inverted	CML-I	Input from Host	3		
6	TX4n	Transmitter Data Inverted	CML-I	Input from Host	3		
7	GND	Ground		2	1		
8	ТХбр	Transmitter Data Non-Inverted	CML-I	Input from Host	3		
9	TX6n	Transmitter Data Inverted	CML-I	Input from Host	3		
10	GND	Ground			1		
11	TX8p	Transmitter Data Non-Inverted	CML-I	Input from Host	3		
12	TX8n	Transmitter Data Inverted	CML-I	Input from Host	3		
13	GND	Ground			1		
14	SCL	2-wire Serial interface clock	LVCMOS-I/O	Bi-directional	3	Open-Drain with pull- up resistor on Host	
15	VCC	+3.3V Power		Power from Host	2		
16	VCC	+3.3V Power		Power from Host	2		
17	LPWn/PRSn	Low-Power Mode / Module Present	Multi-Level	Bi-directional	3	See pin description for required circuit	
18	GND	Ground			1		
19	RX7n	Receiver Data Inverted	CML-O	Output to Host	3		
20	RX7p	Receiver Data Non-Inverted	CML-O	Output to Host	3		
21	GND	Ground			1		
22	RX5n	Receiver Data Inverted	CML-O	Output to Host	3		
23	RX5p	Receiver Data Non-Inverted	CML-O	Output to Host	3		
24	GND	Ground			1		
25	RX3n	Receiver Data Inverted	CML-O	Output to Host	3		
26	RX3p	Receiver Data Non-Inverted	CML-O	Output to Host	3		
27	GND	Ground		i -	1		
28	RX1n	Receiver Data Inverted	CML-O	Output to Host	3		
29	RX1p	Receiver Data Non-Inverted	CML-O	Output to Host	3		
30	GND	Ground			1		
31	GND	Ground			1		
32	RX2p	Receiver Data Non-Inverted	CML-O	Output to Host	3		

Pin#	Symbol	ol Description Logic		Direction	Plug Sequence	Notes	
33	RX2n	Receiver Data Inverted	CML-O	Output to Host	3		
34	GND	Ground			1		
35	RX4p	Receiver Data Non-Inverted	CML-O	Output to Host	3		
36	RX4n	Receiver Data Inverted	CML-O	Output to Host	3		
37	GND	Ground			1		
38	RX6p	Receiver Data Non-Inverted	CML-O	Output to Host	3		
39	RX6n	Receiver Data Inverted	CML-O	Output to Host	3	3	
40	GND	Ground			1		
41	RX8p	Receiver Data Non-Inverted	CML-O	Output to Host	3		
42	RX8n	Receiver Data Inverted	CML-O	Output to Host	3		
43	GND	Ground			1		
44	INT/RSTn	Module Interrupt / Module Reset	Multi-Level	Bi-directional	3	See pin description for required circuit	
45	VCC	+3.3V Power		Power from Host	2		
46	vcc	+3.3V Power		Power from Host	2		
47	SDA	2-wire Serial interface data	LVCMOS-I/O	Bi-directional	3	Open-Drain with pull- up resistor on Host	
48	GND	Ground			1		
49	TX7n	Transmitter Data Inverted	CML-I	Input from Host	3		
50	TX7p	Transmitter Data Non-Inverted	CML-I	Input from Host	3		
51	GND	Ground			1		
52	TX5n	Transmitter Data Inverted	CML-I	Input from Host	3		
53	TX5p	Transmitter Data Non-Inverted	CML-I	Input from Host	3		
54	GND	Ground			1		
55	TX3n	Transmitter Data Inverted	CML-I	Input from Host	3		
56	ТХЗр	Transmitter Data Non-Inverted	CML-I	Input from Host	3		
57	GND	Ground			1		
58	TX1n	Transmitter Data Inverted	CML-I	Input from Host	3	1	
59	TX1p	Transmitter Data Non-Inverted	CML-I	Input from Host	3		
60	GND	Ground			1		

Figure 4. Extender housing OSFP SMT connector pin





Mechanical Dimensions 100. 2 L±30mm 49. 0 L0

Figure 5. OSFP Mechanical Specifications

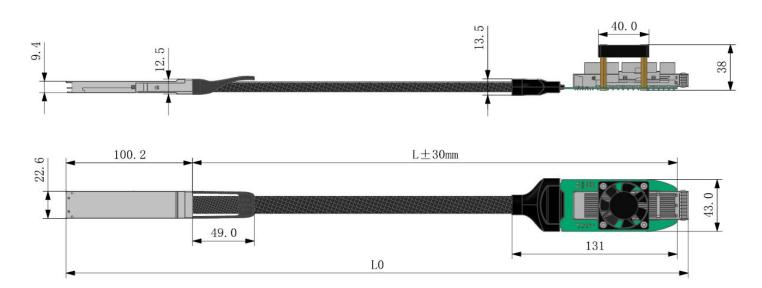


Figure 6. OSFP-RHS Mechanical Specifications

Extender housing pin

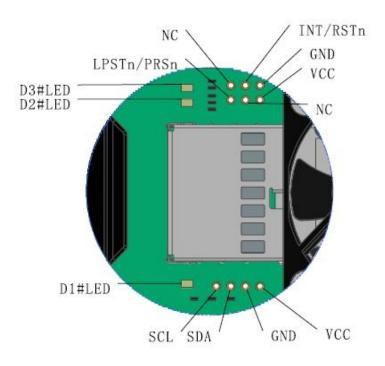


Figure 7. Extender housing pin







Regulatory Compliance

FIBERSTAMP's 800G OSFP immersion cooling extender meet the requirements of the following standards:

Feature	Standard
	EN 62368-1: 2014
Electrical Safety	IEC 62368-1:2014
	UL 62368-1:2014
Environmental protection	Directive 2011/65/EU with amendment(EU)2015/863
	EN55032: 2015
CE EMC	EN55035: 2017
CE EINIC	EN61000-3-2:2014
	EN61000-3-3:2013
FCC	FCC Part 15, Subpart B; ANSI C63.4-2014

Ordering information

Part Number	Length	Description
ESOE DC904 D02	20am	800G OSFP extender with high speed cable, with PET jacket, with
FSOE-PC801-D03	30cm	fan,0.3 meter length as of Figure 5.
ECDE D0004 D00	20	800G OSFP-RHS extender with high speed cable, with PET jacket ,
FSRE-PC801-D03	30cm	with fan, 0.3 meter length as of Figure 5.

- 1.The length (meter) and wire gage of FSOE-PC801-DXX is decimal and can be customizable
- 2. The extender housing also can be customizable as OSFP RHS form.
- 3.Length as "L" of Mechanical Specifications

Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by FIBERSTAMP before they become applicable to any particular order or contract. In accordance with the FIBERSTAMP policy of continuous improvement specifications may change without notice.

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http://www.fiberstamp.com

Revision History

Revision	Date	Description
V0	28-Nov-2025	Advance Release.